MSKSEMI















ESD

TVS

TSS

MOV

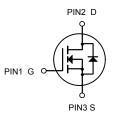
GDT

PLED

Broduct data sheet







N-Channel MOSFET

Description

The AO3422MI-MS uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 $V_{DS} = 60V, I_{D} = 4.5A$

 $R_{DS(ON)} < 75 m\Omega$ @ $V_{GS}=10V$

 $R_{DS(ON)}$ < 90m Ω @ V_{GS} =4.5V

Application

High power and current handing capability
Lead free product is acquired
Surface mount package
PWM applications
Load switch
Power management

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit	
V _{DS}	Drain-Source Voltage	60	V	
Vgs	Gate-Source Voltage	±20	V	
I _D	Drain Current-Continuous	4.5	А	
Іпм	Drain Current-Pulsed (Note 1)	15	А	
P _D	Maximum Power Dissipation	8	W	
Тл,Тѕтс	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$	
Reja	Thermal Resistance,Junction-to-Ambient (Note 2)	89	°C/W	



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	60			V	
D	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =5A		65	75	mΩ	
R _{DS(ON)}		V _{GS} =4.5V , I _D =5A		80	90	1115.2	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	1.2		2.5	V	
lane	Drain-Source Leakage Current	V _{DS} =48V , V _{GS} =0V , T _J =25°C			1 uA		
IDSS		V _{DS} =48V , V _{GS} =0V , T _J =55°C			5	- uA	
Igss	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =5A		7		S	
Qg	Total Gate Charge (10V)			5.5			
Qgs	Gate-Source Charge	V _{DS} =12V , V _{GS} =10V , I _D =5A		1.8		nC	
Q _{gd}	Gate-Drain Charge			2.4			
T _{d(on)}	Turn-On Delay Time			6			
Tr	Rise Time	V_{DD} =12V , V_{GS} =10V , R_{G} =3.3 Ω		10			
T _{d(off)}	Turn-Off Delay Time	I _D =5A		15		ns	
Tf	Fall Time			7			
Ciss	Input Capacitance			695			
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		148		pF	
Crss	Reverse Transfer Capacitance			7			

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,5}	V- V- OV Force Current			17	Α
I _{SM}	Pulsed Source Current ^{2,5}	V _G =V _D =0V , Force Current			50	Α
V_{SD}	Diode Forward Voltage ²	V_{GS} =0V , I_{S} =1A , T_{J} =25 $^{\circ}$ C			1.2	V

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =15A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

Typical Characteristics

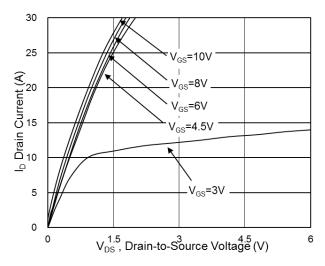


Fig.1 Typical Output Characteristics

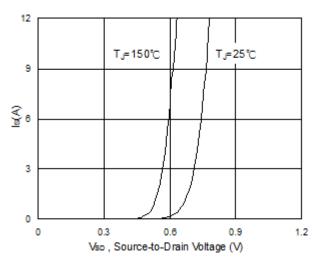


Fig.3 Forward Characteristics of Reverse

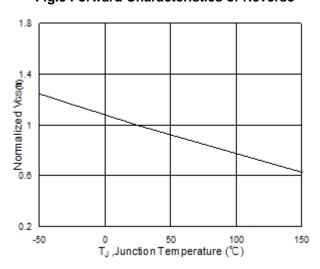


Fig.5 Normalized V_{GS(th)} vs. T_J

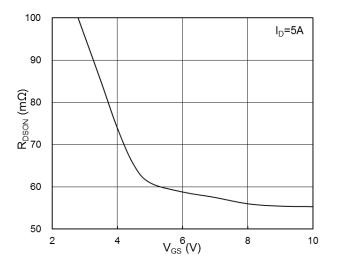


Fig.2 On-Resistance vs. Gate-Source Voltage

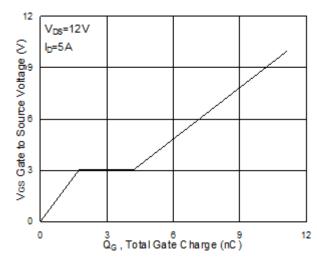


Fig.4 Gate-Charge Characteristics

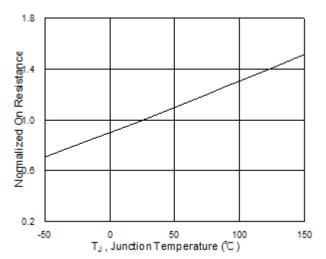
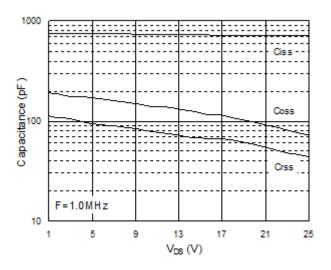


Fig.6 Normalized R_{DSON} vs. T_J





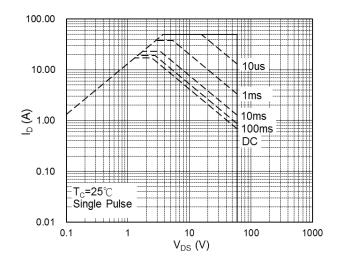


Fig.7 Capacitance

Fig.8 Safe Operating Area

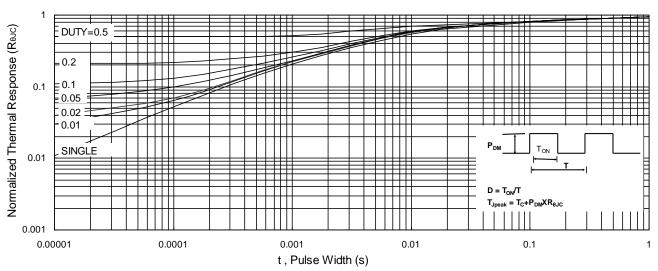


Fig.9 Normalized Maximum Transient Thermal Impedance

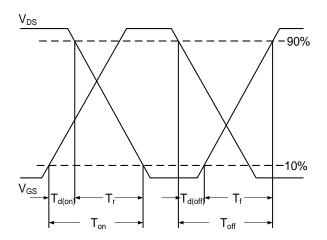


Fig.10 Switching Time Waveform

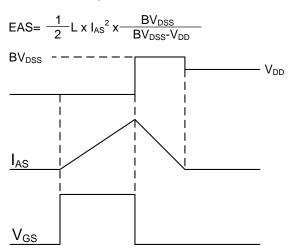
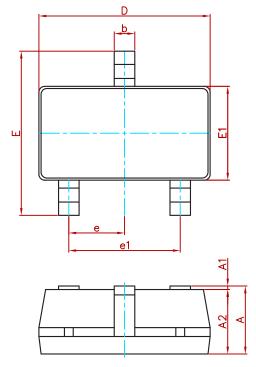
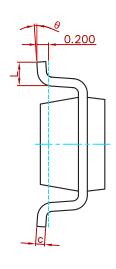


Fig.11 Unclamped Inductive Switching Waveform

emiconductor C

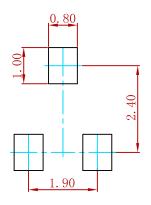
PACKAGE MECHANICAL DATA





Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E1	1.500	1.700	0.059	0.067	
E	2.650	2.950	0.104	0.116	
е	0.950(BSC)	0.037((BSC)	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
AO3422MI-MS	SOT-23-3L	3000



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